

1. General description

Dual Silicon Carbide Schottky diode in a 3-lead TO-247 plastic package, designed for high frequency switched-mode power supplies.

2. Features and benefits

- Highly stable switching performance
- High forward surge capability IFSM
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- Electrical Vehicle Charger
- Motor Drives

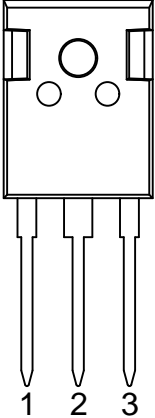
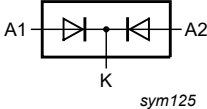
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V _{RRM}	repetitive peak reverse voltage			-	-	650	V
I _{O(AV)}	limiting average output current	T _{mb} ≤ 105 °C; δ _{factor} = 0.5 ; square-wave pulse; both diodes conducting; Fig. 1 ; Fig. 2 ; Fig. 3 ; Fig. 4		-	-	20	A
T _j	junction temperature			-	-	175	°C
Static characteristics							
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; Fig. 6		-	1.5	1.7	V
		I _F = 10 A; T _j = 150 °C; Fig. 6		-	1.8	2.1	V
Dynamic characteristics							
Q _r	recovered charge	I _F = 10 A; dI _F /dt = 500 A/μs; V _R = 400 V; T _j = 25 °C; Fig. 7		-	14	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode	 <p>TO-247 (SOT429N)</p>	
2	K	cathode		
3	A2	anode		
mb	mb	mounting base; connected to cathode		

6. Ordering information

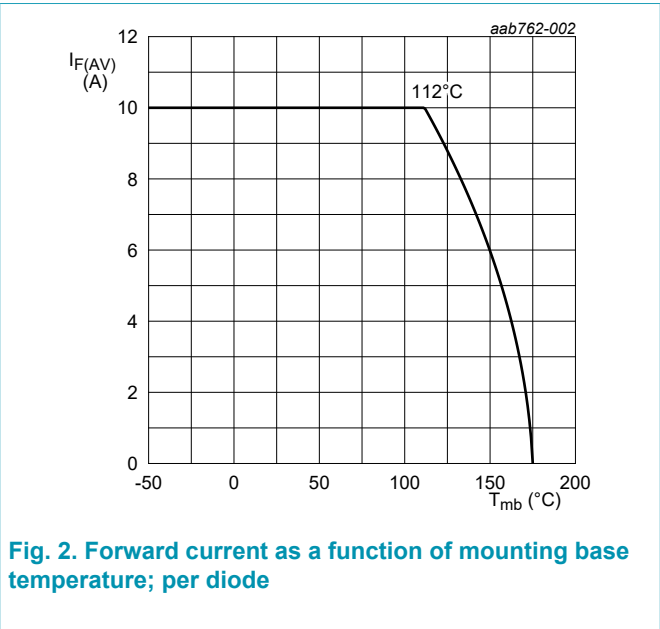
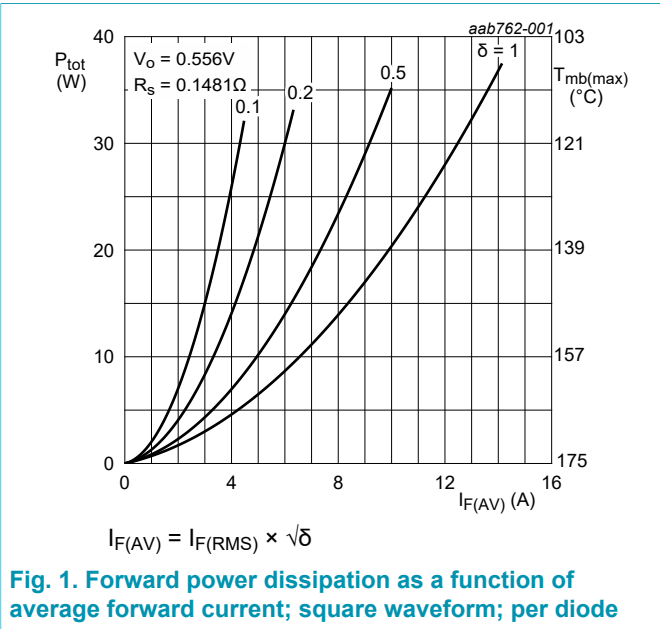
Table 3. Ordering information

Type number	Package		
	Name	Description	Version
NXPSC20650W	TO-247	Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247	SOT429N

7. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	650	V
V _{RWM}	crest working reverse voltage		-	650	V
V _R	reverse voltage	DC	-	650	V
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 112 °C; square-wave pulse; per diode	-	20	A
I _{O(AV)}	limiting average output current	T _{mb} ≤ 105 °C; δ _{factor} = 0.5 ; square-wave pulse; both diodes conducting; Fig. 1; Fig. 2; Fig. 3; Fig. 4	-	20	A
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; square-wave pulse; per diode	-	50	A
		t _p = 10 μs; T _{j(init)} = 25 °C; square-wave pulse; per diode	-	450	A
T _{stg}	storage temperature		-55	175	°C
T _j	junction temperature		-	175	°C



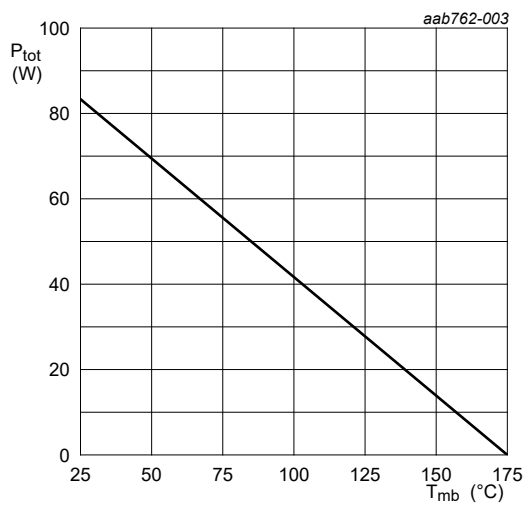


Fig. 3. Total power dissipation as a function of mounting base temperature; per diode

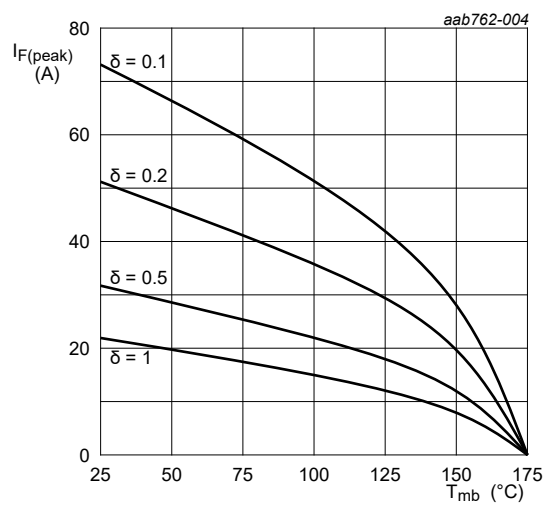
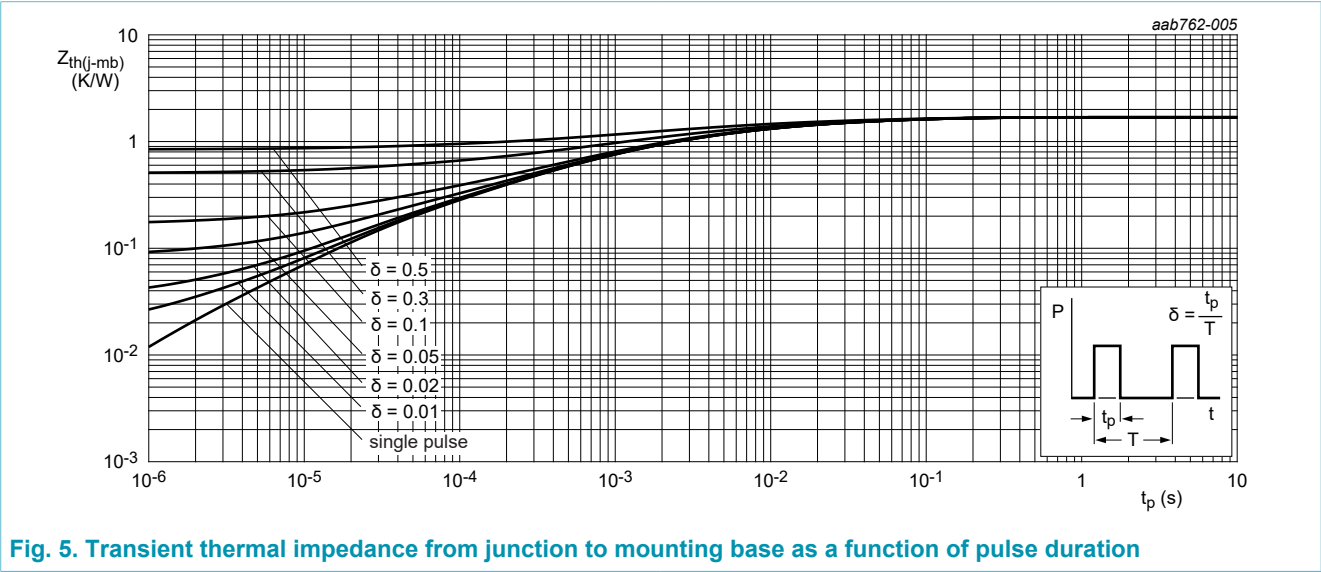


Fig. 4. Current derating as a function of mounting base temperature; per diode

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	per diode; Fig. 5	-	-	1.8	K/W
		both diodes conducting	-	-	1	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W

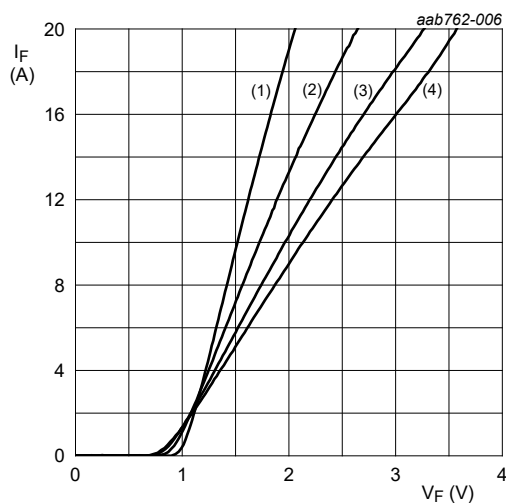


9. Characteristics

Table 6. Characteristics

characteristics are per diode unless otherwise stated

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; Fig. 6		-	1.5	1.7	V
		I _F = 10 A; T _j = 150 °C; Fig. 6		-	1.8	2.1	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C		-	-	250	μA
		V _R = 650 V; T _j = 150 °C		-	-	800	μA
Dynamic characteristics							
Q _r	recovered charge	I _F = 10 A; dI _F /dt = 500 A/μs; V _R = 400 V; T _j = 25 °C; Fig. 7		-	14	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C		-	300	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C		-	32	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C		-	25	-	pF



- (1) $T_j = 25\text{ °C}$; typical values
 (2) $T_j = 100\text{ °C}$; typical values
 (3) $T_j = 150\text{ °C}$; typical values
 (4) $T_j = 175\text{ °C}$; typical values

Fig. 6. Forward current as a function of forward voltage; typical values; per diode

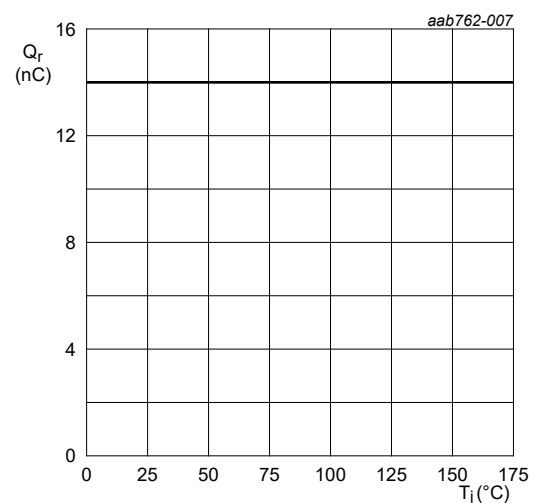


Fig. 7. Recovered charge as a function of junction temperature; per diode

10. Package outline

Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247 SOT429N

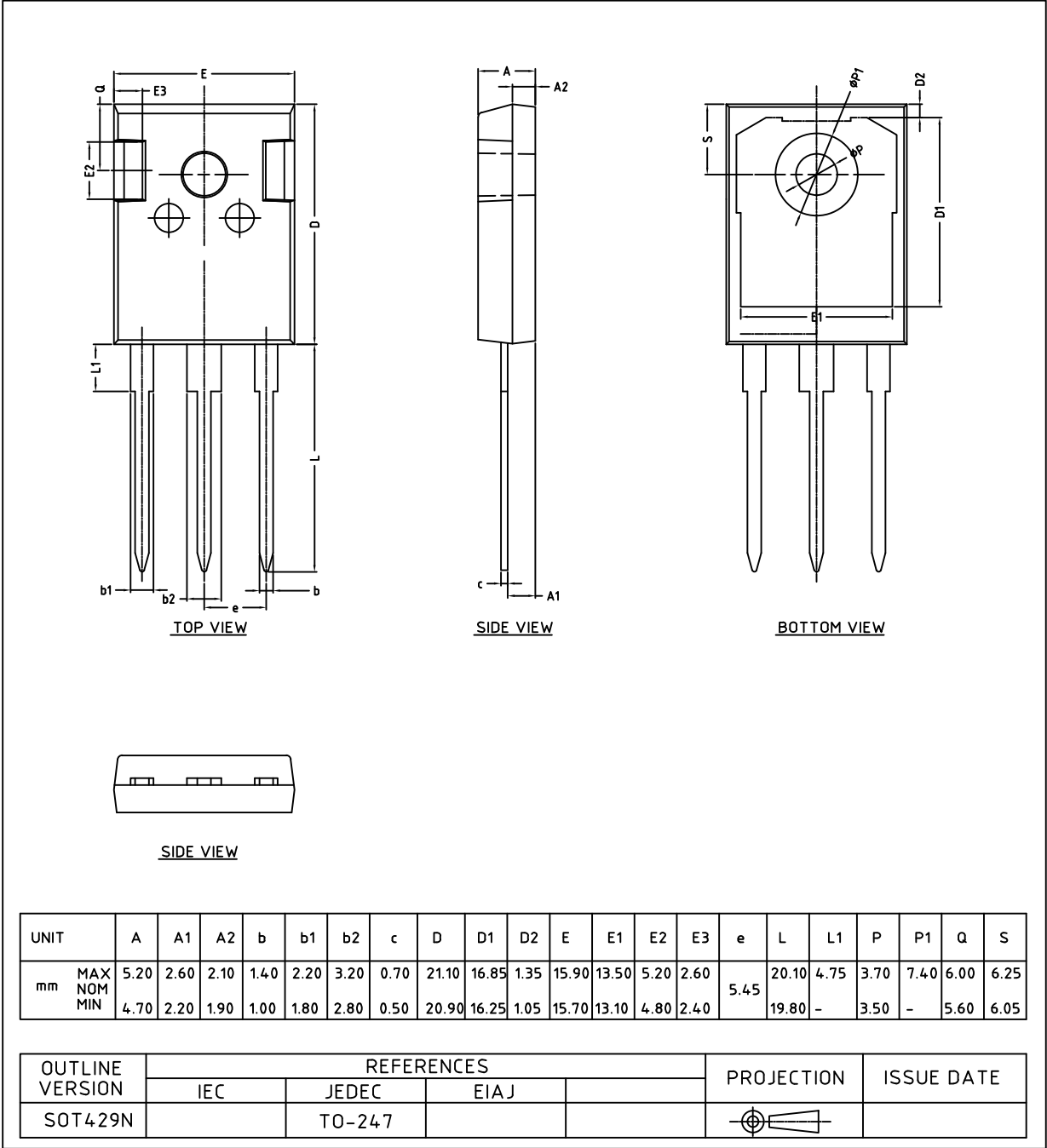


Fig. 8. Package outline TO-247 (SOT429N)

11. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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